

Electronic Information Disclosure Statement



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PULL-ACTION DE-LATCHING MECHANISMS FOR FIBER OPTIC MODULES

Application: 
09/939413

Confirmation: 4302

Applicant(s): Liew Chiu

Docket
Number: 3918P017X

Group Art
Unit: 2874

Examiner: Not Assigned

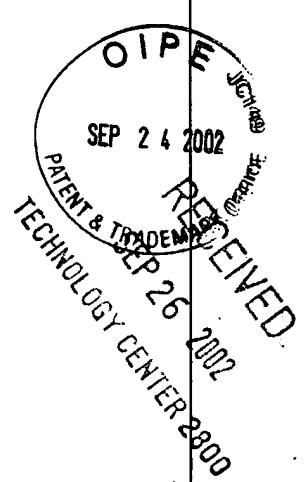
search string: (3,803,409 or 3,806,225 or 3,809,908 or 3,951,514 or 4,140,367 or 4,149,072 or 4,167,303 or 4,268,114 or 4,273,413 or 4,406,514 or 4,427,879 or 4,439,006 or 4,449,784 or 4,470,660 or 4,477,146 or 4,522,463 or 4,548,467 or 4,553,813 or 4,553,814 or 4,611,887 or 4,678,264 or 4,684,210 or 4,737,008 or 4,762,388 or 4,767,179 or 4,787,706 or 4,798,440 or 4,798,430 or 4,840,451 or 4,944,568 or 4,960,317 or 4,969,924 or 4,986,625 or 5,005,939 or 5,016,968 or 5,042,891 or 5,071,219 or 5,073,045 or 5,073,046 or 5,076,656 or 5,082,344 or 5,091,991 or 5,099,307 or 5,101,463 or 5,109,453 or 5,113,467 or 5,117,476 or 5,125,849 or 5,134,679 or 5,140,663 or 5,142,597 or 5,155,786 or 5,159,652 or 5,199,093 or 5,243,678 or 5,259,052 or 5,274,729 or 5,283,680 or 5,295,212 or 5,315,679 or 5,317,663 or 5,325,454 or 5,329,604 or 5,333,221 or 5,337,396 or 5,361,318 or 5,390,268 or 5,398,295 or 5,452,388 or 5,469,526 or 5,481,634 or 5,515,468 or 5,528,408 or 5,548,677 or 5,600,470 or 5,604,831 or 5,896,480 or 6,206,582 or 6,341,899 or 6,369,924 or Des.389,802 or Des.446,501).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

Init	Citation No.	Patent Number	Date	Bar Code	Patentee	Class	Subclass

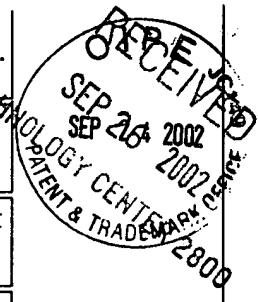
P01	3,803,409	1974-04-09	████████████████	Prochazka
P02	3,806,225	1974-04-23	████████████████	Codrino
P03	3,809,908	1974-05-07	████████████████	Clanton
P04	3,951,514	1976-04-20	████████████████	Medina, Jr.
P05	4,140,367	1979-02-20	████████████████	Makuch et al.
P06	4,149,072	1979-04-10	████████████████	Smith et al.
P07	4,167,303	1979-09-11	████████████████	Bowen et al.
P08	4,268,114	1981-05-19	████████████████	dAuria et al.
P09	4,273,413	1981-06-16	████████████████	Bendiksen et al.
P10	4,406,514	1983-09-27	████████████████	Hillegonds et al.
P11	4,427,879	1984-01-24	████████████████	Becher et al.
P12	4,439,006	1984-03-27	████████████████	Stevenson
P13	4,449,784	1984-05-22	████████████████	Basov et al.
P14	4,470,660	1984-09-11	████████████████	Hillegonds et al.
P15	4,477,146	1984-10-16	████████████████	Bowen et al.
P16	4,522,463	1985-06-11	████████████████	Schwenda et al.
P17	4,548,467	1985-10-22	████████████████	Stoerk et al.
P18	4,553,813	1985-11-19	████████████████	McNaughton et al.
P19	4,553,814	1985-11-19	████████████████	Bahl et al.



P20	4,611,887	1986-09-16	████████████████	Glover et al.
P21	4,678,264	1987-07-07	████████████████	Bowen et al.
P22	4,684,210	1987-08-04	████████████████	Matsunaga et al.
P23	4,737,008	1988-04-12	████████████████	Ohyama et al.
P24	4,762,388	1988-08-09	████████████████	Tanaka et al.
P25	4,767,179	1988-08-30	████████████████	Sampson et al.
P26	4,787,706	1988-11-29	████████████████	Cannon, Jr. et al.
P27	4,798,440	1989-01-17	████████████████	Hoffer et al.
P28	4,798,430	1989-01-17	████████████████	Johnson et al.
P29	4,840,451	1989-06-20	████████████████	Sampson et al.
P30	4,944,568	1990-07-31	████████████████	Danbach et al.
P31	4,960,317	1990-10-02	████████████████	Briggs et al.
P32	4,969,924	1990-11-13	████████████████	Suverison et al.
P33	4,986,625	1991-01-22	████████████████	Yamada et al.
P34	5,005,939	1991-04-09	████████████████	Arvanitakis et al.
P35	5,016,968	1991-05-21	████████████████	Hammond et al.
P36	5,042,891	1991-08-27	████████████████	Mulholland et al.
P37	5,071,219	1991-12-10	████████████████	Yurtin et al.
P38	5,073,045	1991-12-17	████████████████	Abendschein

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P39	5,073,046	1991-12-17	████████████████████	Edwards et al.
P40	5,076,656	1991-12-31	████████████████████	Briggs et al.
P41	5,082,344	1992-01-21	████████████████████	Mulholland et al.
P42	5,091,991	1992-02-25	████████████████████	Briggs et al.
P43	5,099,307	1992-03-24	████████████████████	Go et al.
P44	5,101,463	1992-03-31	████████████████████	Cubukciyan et al.
P45	5,109,453	1992-04-28	████████████████████	Edwards et al.
P46	5,113,467	1992-05-12	████████████████████	Peterson et al.
P47	5,117,476	1992-03-26	████████████████████	Yingst et al.
P48	5,125,849	1992-06-30	████████████████████	Briggs et al.
P49	5,134,679	1992-07-28	████████████████████	Robin et al.
P50	5,140,663	1992-08-18	████████████████████	Edwards et al.
P51	5,142,597	1992-08-25	████████████████████	Mulholland et al.
P52	5,155,786	1992-10-13	████████████████████	Ecker et al.
P53	5,159,652	1992-10-27	████████████████████	Grassin D'Alphonse et al.
P54	5,199,093	1993-03-30	████████████████████	Longhurst
P55	5,243,678	1993-09-07	████████████████████	Schaffer et al.
P56	5,259,052	1993-11-02	████████████████████	Briggs et al.
P57	5,274,729	1993-12-	████████████████████	King et al.



		28			
P58	5,283,680	1994-02-01	████████████████████	Okugawa et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P59	5,295,212	1994-03-15	████████████████████	Morton et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P60	5,315,679	1994-05-24	████████████████████	Baldwin et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P61	5,317,663	1994-05-31	████████████████████	Beard et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P62	5,325,454	1994-06-28	████████████████████	Rittle et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P63	5,329,604	1994-07-12	████████████████████	Baldwin et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P64	5,333,221	1994-07-26	████████████████████	Briggs et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P65	5,337,396	1994-08-09	████████████████████	Chen et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P66	5,361,318	1994-11-01	████████████████████	Go et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P67	5,390,268	1995-02-14	████████████████████	Morlion et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P68	5,398,295	1995-03-14	████████████████████	Chang et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P69	5,452,388	1995-09-19	████████████████████	Rittle et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P70	5,469,526	1995-11-21	████████████████████	Rawlings	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P71	5,481,634	1996-01-02	████████████████████	Anderson et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P72	5,515,468	1996-05-07	████████████████████	DeAndrea et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P73	5,528,408	1996-06-18	████████████████████	McGinley et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P74	5,548,677	1996-08-20	████████████████████	Kakii et al.	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
P75	5,600,470	1997-02-04	████████████████████	Walsh	RECEIVED SEP 26 2002 TECHNOLOGY CENTER 2800 U.S. PATENT & TRADEMARK OFFICE CPTD 143
		1997-02-	████████████████████		

P76	5,604,831	18		Dittman et al.
P77	5,896,480	1999-04-20		Scharf et al.
P78	6,206,582	2001-03-27		Gilliland
P79	6,341,899	2002-01-29		Shirakawa et al.
P80	6,369,924	2002-04-09		Scharf et al.
P81	Des.389,802	1998-01-27		Vernon
P82	Des.446,501	2001-08-14		Donnell et al.



Remarks

(Remarks are not for responding to an office action.)

Applicants, in accordance with their duty of disclosure under 37 CFR 1.56 and in accordance with 37 CFR 1.97(b)(3), hereby submit this Electronic Information Disclosure Statement citing U.S. Patent Documents for consideration by the Examiner. * Pursuant to 37 CFR 1.97, the submission of this Electronic Information Disclosure Statement is not to be construed as a representation that a search has been made and is not to be construed as an admission that the information cited in this statement is material to patentability. * This Information Disclosure Statement is being filed prior to a substantive examination of the claims. Pursuant to 37 CFR 1.97(b), no fee should be required for the filing of this Information Disclosure Statement. In the event it is determined that a fee is due, please charge the fee to Deposit Account 02-2666. * Applicants respectfully requests that the cited documents be considered and that the form be initialed by the Examiner to indicate such consideration and a copy thereof be returned to Applicants' attorney of record. *

Signature

Examiner Name	Date



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Stylesheet Version: 1.0

Submission Type: Information
Disclosure Statement

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Application Number: 09/939,413
Attorney Docket Number: 3918P017X

PULL-ACTION DE-LATCHING MECHANISMS FOR FIBER OPTIC MODULES

First Named Inventor: Liew C. Chiu

SUBMITTED BY

Name: Julio Loza

Registration Number: 47,758

Electronic Signature Mark: /Julio
Loza/ Date Signed: 20020924

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